

L Number	Hits	Search Text	DB	Time stamp
1	5195	stitch\$3 near5 bond\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/01 02:32
2	124	(stitch\$3 near5 bond\$3) same (chip\$1 die) with substrate\$1	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/01 02:33
3	112	((stitch\$3 near5 bond\$3) same (chip\$1 die) with substrate\$1) same wir\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/10/01 02:34